



S&H Form: (02/05)

REPLY/AMENDMENT FEE TRANSMITTAL				Attorney Docket No.		1572.1165				
				Applicati	on Number	10/682,481				
						October 10, 2003				
				First Named Inventor		Jang-hyoun YOUM et al.				
						2835				
AMOUNT ENCLOSED			Examiner Name		Datskovskiy	Datskovskiy, Michael V.				
FEE CALCULATION (fees effective 12/08/04)										
CLAIMS AS AMENDED	Claims Remaining After Amendment		Highest Ni Previously I		Number Extra	Ra	ate	Calculations		
TOTAL CLAIMS	21		- 24 =		0	X \$ 50.	.00 =	\$ 0.00		
INDEPENDENT CLAIMS	3		- 3=		0	X \$ 200	= 00.0	0.00		
Since an Official Action set an <u>original</u> due date of <u>December 14, 2005</u> , no extension of time fees										
are due:										
If Notice of Appeal is enclosed, add (\$500.00)										
If Statutory Disclaimer under Rule 20(d) is enclosed, add fee (\$130.00)										
Information Disclosure Statement (Rule 1.17(p)) (\$180.00)										
Total of above Calculations =									0.00	
Reduction by 50% for filing by small entity (37 CFR 1.9, 1.27 & 1.28)										
TOTAL FEES DUE =									0.00	
(1) If entry (1) is less than entry (2), entry (3) is "0".										
(2) If entry (2) is less than 20, change entry (2) to "20".										
(4) If entry (4) is less than entry (5), entry (6) is "0".  (5) If entry (5) is less than 3, change entry (5) to "3".										
METHOD OF PAYMENT										
☐ Check en	Check enclosed as payment.									
Charge "TOTAL FEES DUE" to the Deposit Account No. below.										
No payment is enclosed.     ■    ■    ■    ■    ■    ■    ■										
GENERAL AUTHORIZATION										
☐ If the above-noted "AMOUNT ENCLOSED" is not correct, the Commissioner is hereby authorized to credit										
1	any overpayment or charge any additional fees necessary to:									
	Deposit Account No. 19-3935									
Deposit Account Name STAAS & HALSEY LLP										
The Commissioner is also authorized to credit any overpayments or charge any additional fees required under 37 CFR 1.16 (filing fees) or 37 CFR 1.17 (processing fees) during the prosecution of this application, including										
any related application(s) claiming benefit hereof pursuant to 35 USC § 120 (e.g.,										
continuations/divisionals/CIPs under 37 CFR 1.53(b) and/or continuations/divisionals/CPAs under 37 CFR										
1.53(d)) to maintain pendency hereof or of any such related application.										
SUBMITTED BY: STAAS & HALSEY LLP										
Typed Name Gregory W. Harper					<del> </del>	Reg. No.	55,24	248		
Signature	y W. Hary			Date		or 8,2005 as & Halsey LLP				

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Docket No.: 1572.1165

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Jang-hyoun YOUM et al.

Serial No. 10/682,481

Group Art Unit: 2835

Confirmation No. 1459

Filed: October 10, 2003

Examiner: Michael V. Datskovskiy

For: HEAT DISSIPATION SYSTEM FOR SEMICONDUCTOR DEVICE

## <u>AMENDMENT</u>

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

This is in response to the Office Action mailed September 14, 2005, and having a period for response set to expire on December 14, 2005.

The following amendments and remarks are respectfully submitted. Reconsideration of the claims is respectfully requested.